

FAST CMOS OCTAL BIDIRECTIONAL TRANSCEIVER

IDT74FCT2245AT/CT

FEATURES:

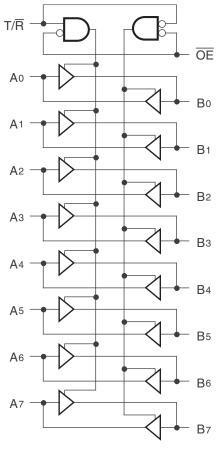
- · A and C grades
- Low input and output leakage ≤1µA (max.)
- CMOS power levels
- · True TTL input and output compatibility:
 - VOH = 3.3V (typ.)
 - -Vol = 0.3V (typ.)
- · Meets or exceeds JEDEC standard 18 specifications
- Resistor outputs -15mA IOH, 12mA IOL
- Reduced system switching noise
- · Available in SOIC and QSOP packages

DESCRIPTION:

The IDT octal bidirectional transceivers are built using an advanced dual metal CMOS technology. The FCT2245T is designed for asynchronous two-way communication between data buses. The transmit/receive (T/\overline{R}) input determines the direction of data flow through the bidirectional transceiver. Transmit (active high) enables data from A ports to B ports, and receive (active low) from B ports to A ports. The output enable (\overline{OE}) input, when high, disables both A and B ports by placing them in high Z condition.

The FCT2245T has balanced drive outputs with current limiting resistors. This offers low ground bounce, minimal undershoot and controlled output fall times-reducing the need for external series terminating resistors. The FCT2245T parts are plug-in replacements for FCT245T parts.

FUNCTIONAL BLOCK DIAGRAM

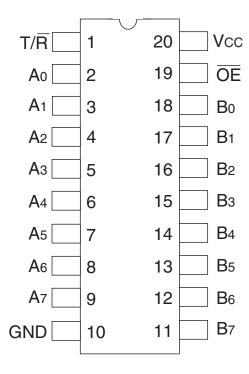


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INDUSTRIAL TEMPERATURE RANGE

APRIL 2016

PIN CONFIGURATION



SOIC/ QSOP TOP VIEW

ABSOLUTE MAXIMUM RATINGS(1)

Symbol	Description	Max	Unit
VTERM ⁽²⁾	Terminal Voltage with Respect to GND	-0.5 to +7	V
VTERM ⁽³⁾	Terminal Voltage with Respect to GND	-0.5 to Vcc+0.5	V
Tstg	Storage Temperature	-65 to +150	°C
lout	DC Output Current	-60 to +120	mA

NOTES:

- 1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability. No terminal voltage may exceed Vcc by +0.5V unless otherwise noted.
- 2. Inputs and Vcc terminals only.
- 3. Output and I/O terminals only.

CAPACITANCE (TA = +25°C, F = 1.0MHz)

Symbol	Parameter ⁽¹⁾	Conditions	Тур.	Max.	Unit
CIN	Input Capacitance	VIN = 0V	6	10	pF
Соит	Output Capacitance	Vout = 0V	8	12	pF

NOTE:

1. This parameter is measured at characterization but not tested.

PIN DESCRIPTION

Pin Names	Description	
ŌĒ	OE Output Enable Input (Active LOW)	
T/R	Transmit/Receive Input	
A0 - A7 Side A Inputs or 3-State Outputs		
Bo - B7 Side BInputs or 3-State Outputs		

FUNCTION TABLE(1)

Inp	outs	
ŌĒ	T/R	Outputs
L	L	Bus B Data to Bus A
L	Н	Bus A Data to Bus B
Н	Х	High Z State

- 1. H = HIGH Voltage Level
 - X = Don't Care
 - L = LOW Voltage Level

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

Industrial: TA = -40°C to +85°C, VCC = $5.0V \pm 5\%$

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Unit
VIH	Input HIGH Level	Guaranteed Logic HIGH Level		2	_	_	V
VIL	Input LOW Level	Guaranteed Logic LOW Level		_	_	0.8	V
lih	Input HIGH Current ⁽⁴⁾	Vcc = Max.	VI = 2.7V	_	_	±1	μA
lıL	Input LOW Current ⁽⁴⁾	Vcc = Max.	Vı = 0.5V	_	_	±1	μA
lozh	High Impedance Output Current	Vcc = Max.	VI = 2.7V	_	_	±1	μA
lozL	(3-State Output Pins)(4)		VI = 0.5V	_	_	±1	
lı	Input HIGH Current ⁽⁴⁾	Vcc = Max., Vı = Vcc (Max.)		_	_	±1	μA
Vik	Clamp Diode Voltage	Vcc = Min., IIN = -18mA		_	-0.7	-1.2	V
VH	Input Hysteresis	_		_	200	_	mV
Icc	Quiescent Power Supply Current	Vcc = Max. Vin = GND or Vcc			0.01	1	mA

OUTPUT DRIVE CHARACTERISTICS

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Unit
IODL	Output LOW Current	Vcc = 5V, Vin = Vih or Vil, Vout = 1.5V ⁽³⁾		16	48	_	mA
IODH	Output HIGH Current	VCC = 5V, VIN = VIH or VIL, VOUT = 1.5V(3)		-16	-48	_	mA
Voн	Output HIGH Voltage	Vcc = Min	Iон = –15mA	2.4	3.3	_	V
		VIN = VIH or VIL					
Vol	Output LOW Voltage	Vcc = Min	IoL = 12mA	_	0.3	0.5	V
		VIN = VIH or VIL					

- 1. For conditions shown as Min. or Max., use appropriate value specified under Electrical Characteristics for the applicable device type.
- 2. Typical values are at Vcc = 5.0V, +25°C ambient.
- 3. Not more than one output should be tested at one time. Duration of the test should not exceed one second.
- 4. The test limit for this parameter is $\pm 5\mu A$ at TA = -55°C.

POWER SUPPLY CHARACTERISTICS

Symbol	Parameter	Test Conditi	ons ⁽¹⁾	Min.	Typ.(2)	Max.	Unit
Δlcc	Quiescent Power Supply Current TTL Inputs HIGH	Vcc = Max. Vin = $3.4V^{(3)}$		_	0.5	2	mA
ICCD	Dynamic Power Supply Current ⁽⁴⁾	Vcc = Max. Outputs Open OE = T/R = GND	VIN = VCC VIN = GND	_	0.06	0.12	mA/ MHz
		One Input Toggling 50% Duty Cycle					
Ic	Total Power Supply Current ⁽⁶⁾	Vcc = Max. Outputs Open fi = 10MHz	VIN = VCC VIN = GND	_	0.6	2.2	mA
		50% Duty Cycle $\overline{OE} = T/\overline{R} = GND$ One BitToggling	VIN = 3.4V VIN = GND		0.9	3.2	
		Vcc = Max. Outputs Open fi = 2.5MHz	VIN = VCC VIN = GND	_	1.2	3.4(5)	
		50% Duty Cycle OE = T/R = GND Eight Bits Toggling	VIN = 3.4V VIN = GND	_	3.2	11.4 ⁽⁵⁾	

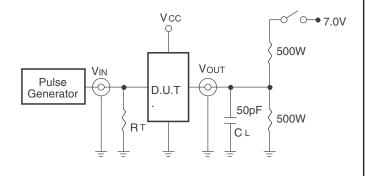
- 1. For conditions shown as Min. or Max., use appropriate value specified under Electrical Characteristics for the applicable device type.
- 2. Typical values are at Vcc = 5.0V, +25°C ambient.
- 3. Per TTL driven input; (VIN = 3.4V). All other inputs at Vcc or GND.
- 4. This parameter is not directly testable, but is derived for use in Total Power Supply Calculations.
- 5. Values for these conditions are examples of Δ Icc formula. These limits are guaranteed but not tested.
- 6. IC = IQUIESCENT + INPUTS + IDYNAMIC
 - IC = ICC + \triangle ICC DHNT + ICCD (fCP/2+ fiNi)
 - Icc = Quiescent Current
 - Δ Icc = Power Supply Current for a TTL High Input (VIN = 3.4V)
 - DH = Duty Cycle for TTL Inputs High
 - NT = Number of TTL Inputs at DH
 - ICCD = Dynamic Current caused by an Input Transition Pair (HLH or LHL)
 - fcP = Clock Frequency for Register Devices (Zero for Non-Register Devices)
 - fi = Output Frequency
 - Ni = Number of Outputs at fi
- All currents are in milliamps and all frequencies are in megahertz.

SWITCHING CHARACTERISTICS OVER OPERATING RANGE(1)

			74FCT	2245AT	74FC	Г2245СТ	
Symbol	Parameter	Condition ⁽¹⁾	Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	Unit
tPLH	Propagation Delay	CL = 50 pF	1.5	4.6	1.5	4.1	ns
tPHL	A to B, B to A	$RL = 500\Omega$					
tpzh	Output Enable Time		1.5	6.2	1.5	5.8	ns
tpzl	OE to A or B						
tPHZ	Output Disable Time		1.5	5	1.5	4.8	ns
tPLZ	OE to A or B						
tpzh	Output Enable Time		1.5	6.2	1.5	5.8	ns
tpzL	T/\overline{R} to A or $B^{(3)}$						
tPHZ	Output Disable Time		1.5	5	1.5	4.8	ns
tPLZ	T/\overline{R} to A or $B^{(3)}$						

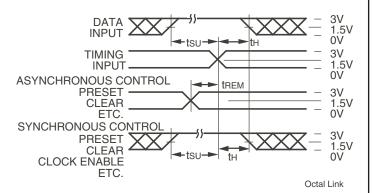
- 1. See test circuit and waveforms.
- 2. Minimum limits are guaranteed but not tested on Propagation Delays.
- 3. This parameter is guaranteed but not tested.

TEST CIRCUITS AND WAVEFORMS

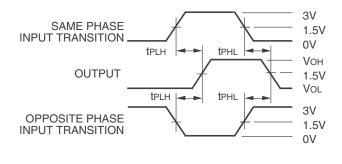


Test Circuits for All Outputs

Octal Link



Set-Up, Hold, and Release Times



Octal Link **Propagation Delay**

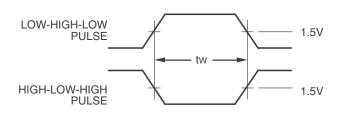
SWITCH POSITION

Test	Switch
Open Drain Disable Low Enable Low	Closed
All Other Tests	Open

DEFINITIONS:

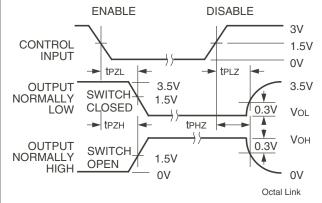
CL = Load capacitance: includes jig and probe capacitance.

RT = Termination resistance: should be equal to ZouT of the Pulse Generator.



Pulse Width

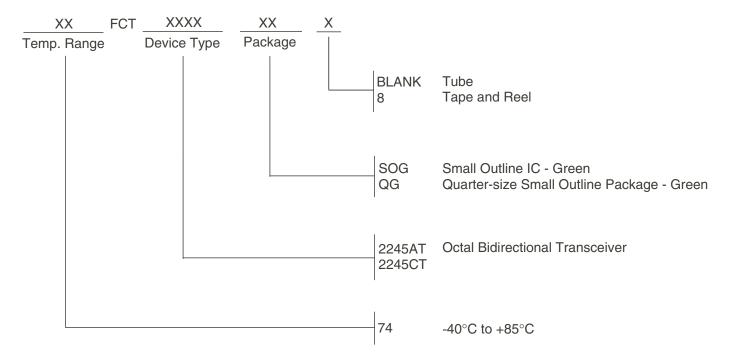
Octal Link



Enable and Disable Times

- 1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.
- 2. Pulse Generator for All Pulses: Rate \leq 1.0MHz; tF \leq 2.5ns; tR \leq 2.5ns.

ORDERING INFORMATION



Datasheet Document History

09/29/2009 Pg. 7 Updated the ordering information by removing the "IDT" notation and non RoHS part.

04/21/2016 Pg. 7 Updated the ordering information by adding Tube, Tape and Reel.

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Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan www.renesas.com

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